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Intel - EPF81500AQC240-3N Datasheet



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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Details	
Product Status	Obsolete
Number of LABs/CLBs	162
Number of Logic Elements/Cells	1296
Total RAM Bits	-
Number of I/O	181
Number of Gates	16000
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	240-BFQFP
Supplier Device Package	240-PQFP (32x32)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf81500aqc240-3n

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

JTAG BST circuitry	Yes	No	Yes	Yes	No	Yes

...and More Features

Peripheral register for fast setup and clock-to-output delay
 Fabricated on an educated CDAM succession

- Fabricated on an advanced SRAM process
 - Available in a variety of packages with 84 to 304 pins (see Table 2)
 Software design support and automatic place-and-route provided by the Altera[®] MAX+PLUS[®] II development system for Windows-based PCs, as well as Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations
 - Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, and Veribest

Table 2. FLEX 8000 Package Options & I/O Pin Count Note (1)												
Device	84- Pin PLCC	100- Pin TQFP	144- Pin TQFP	160- Pin PQFP	160- Pin PGA	192- Pin PGA	208- Pin PQFP	225- Pin BGA	232- Pin PGA	240- Pin PQFP	280- Pin PGA	304- Pin RQFP
EPF8282A	68	78										
EPF8282AV		78										
EPF8452A	68	68		120	120							
EPF8636A	68			118		136	136					
EPF8820A			112	120		152	152	152				
EPF81188A							148		184	184		
EPF81500A										181	208	208

Note:

(1) FLEX 8000 device package types include plastic J-lead chip carrier (PLCC), thin quad flat pack (TQFP), plastic quad flat pack (PQFP), power quad flat pack (RQFP), ball-grid array (BGA), and pin-grid array (PGA) packages.

General Description

Altera's Flexible Logic Element MatriX (FLEX[®]) family combines the benefits of both erasable programmable logic devices (EPLDs) and fieldprogrammable gate arrays (FPGAs). The FLEX 8000 device family is ideal for a variety of applications because it combines the fine-grained architecture and high register count characteristics of FPGAs with the high speed and predictable interconnect delays of EPLDs. Logic is implemented in LEs that include compact 4-input look-up tables (LUTs) and programmable registers. High performance is provided by a fast, continuous network of routing resources.



Figure 4. FLEX 8000 Carry Chain Operation

Cascade Chain

With the cascade chain, the FLEX 8000 architecture can implement functions that have a very wide fan-in. Adjacent LUTs can be used to compute portions of the function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical AND or logical OR (via De Morgan's inversion) to connect the outputs of adjacent LEs. Each additional LE provides four more inputs to the effective width of a function, with a delay as low as 0.6 ns per LE.

The MAX+PLUS II Compiler can create cascade chains automatically during design processing; designers can also insert cascade chain logic manually during design entry. Cascade chains longer than eight LEs are automatically implemented by linking LABs together. The last LE of an LAB cascades to the first LE of the next LAB.

Figure 5 shows how the cascade function can connect adjacent LEs to form functions with a wide fan-in. These examples show functions of 4n variables implemented with n LEs. For a device with an A-2 speed grade, the LE delay is 2.4 ns; the cascade chain delay is 0.6 ns. With the cascade chain, 4.2 ns is needed to decode a 16-bit address.



Figure 5. FLEX 8000 Cascade Chain Operation

LE Operating Modes

The FLEX 8000 LE can operate in one of four modes, each of which uses LE resources differently. See Figure 6. In each mode, seven of the ten available inputs to the LE—the four data inputs from the LAB local interconnect, the feedback from the programmable register, and the carry-in and cascade-in from the previous LE—are directed to different destinations to implement the desired logic function. The three remaining inputs to the LE provide clock, clear, and preset control for the register. The MAX+PLUS II software automatically chooses the appropriate mode for each application. Design performance can also be enhanced by designing for the operating mode that supports the desired application.

Figure 6. FLEX 8000 LE Operating Modes



Arithmetic Mode



Up/Down Counter Mode



Clearable Counter Mode



Figure 7. FLEX 8000 LE Asynchronous Clear & Preset Modes



Asynchronous Load with Clear



Asynchronous Load with Preset



Asynchronous Load without Clear or Preset



Asynchronous Clear

A register is cleared by one of the two LABCTRL signals. When the CLRn port receives a low signal, the register is set to zero.

Asynchronous Preset

An asynchronous preset is implemented as either an asynchronous load or an asynchronous clear. If DATA3 is tied to VCC, asserting LABCTRL1 asynchronously loads a 1 into the register. Alternatively, the MAX+PLUS II software can provide preset control by using the clear and inverting the input and output of the register. Inversion control is available for the inputs to both LEs and IOEs. Therefore, if a register is preset by only one of the two LABCTRL signals, the DATA3 input is not needed and can be used for one of the LE operating modes.

Asynchronous Clear & Preset

When implementing asynchronous clear and preset, LABCTRL1 controls the preset and LABCTRL2 controls the clear. The DATA3 input is tied to VCC; therefore, asserting LABCTRL1 asynchronously loads a 1 into the register, effectively presetting the register. Asserting LABCTRL2 clears the register.

Asynchronous Load with Clear

When implementing an asynchronous load with the clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear. LABCTRL2 implements the clear by controlling the register clear.

Asynchronous Load with Preset

When implementing an asynchronous load in conjunction with a preset, the MAX+PLUS II software provides preset control by using the clear and inverting the input and output of the register. Asserting LABCTRL2 clears the register, while asserting LABCTRL1 loads the register. The MAX+PLUS II software inverts the signal that drives the DATA3 signal to account for the inversion of the register's output.

Asynchronous Load without Clear or Preset

When implementing an asynchronous load without the clear or preset, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear. Each LE in an LAB can drive up to two separate column interconnect channels. Therefore, all 16 available column channels can be driven by the LAB. The column channels run vertically across the entire device, and share access to LABs in the same column but in different rows. The MAX+PLUS II Compiler chooses which LEs must be connected to a column channel. A row interconnect channel can be fed by the output of the LE or by two column channels. These three signals feed a multiplexer that connects to a specific row channel. Each LE is connected to one 3-to-1 multiplexer. In an LAB, the multiplexers provide all 16 column channels with access to 8 row channels.

Each column of LABs has a dedicated column interconnect that routes signals out of the LABs into the column. The column interconnect can then drive I/O pins or feed into the row interconnect to route the signals to other LABs in the device. A signal from the column interconnect, which can be either the output of an LE or an input from an I/O pin, must transfer to the row interconnect before it can enter an LAB. Table 4 summarizes the FastTrack Interconnect resources available in each FLEX 8000 device.

Table 4. FLEX 8000 FastTrack Interconnect Resources										
Device	Rows	Channels per Row	Columns	Channels per Column						
EPF8282A EPF8282AV	2	168	13	16						
EPF8452A	2	168	21	16						
EPF8636A	3	168	21	16						
EPF8820A	4	168	21	16						
EPF81188A	6	168	21	16						
EPF81500A	6	216	27	16						

Figure 9 shows the interconnection of four adjacent LABs, with row, column, and local interconnects, as well as the associated cascade and carry chains.

Figure 11. FLEX 8000 Row-to-IOE Connections

Numbers in parentheses are for EPF81500A devices. See Note (1).



Note:

- (1) n = 13 for EPF8282A and EPF8282AV devices.
 - *n* = 21 for EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices.
 - n = 27 for EPF81500A devices.

Column-to-IOE Connections

Two IOEs are located at the top and bottom of the column channels (see Figure 12). When an IOE is used as an input, it can drive up to two separate column channels. The output signal to an IOE can choose from 8 of the 16 column channels through an 8-to-1 multiplexer.



Figure 12. FLEX 8000 Column-to-IOE Connections

In addition to general-purpose I/O pins, FLEX 8000 devices have four dedicated input pins. These dedicated inputs provide low-skew, device-wide signal distribution, and are typically used for global clock, clear, and preset control signals. The signals from the dedicated inputs are available as control signals for all LABs and I/O elements in the device. The dedicated inputs can also be used as general-purpose data inputs because they can feed the local interconnect of each LAB in the device.

Signals enter the FLEX 8000 device either from the I/O pins that provide general-purpose input capability or from the four dedicated inputs. The IOEs are located at the ends of the row and column interconnect channels.

I/O pins can be used as input, output, or bidirectional pins. Each I/O pin has a register that can be used either as an input register for external data that requires fast setup times, or as an output register for data that requires fast clock-to-output performance. The MAX+PLUS II Compiler uses the programmable inversion option to invert signals automatically from the row and column interconnect when appropriate.

The clock, clear, and output enable controls for the IOEs are provided by a network of I/O control signals. These signals can be supplied by either the dedicated input pins or by internal logic. The IOE control-signal paths are designed to minimize the skew across the device. All control-signal sources are buffered onto high-speed drivers that drive the signals around the periphery of the device. This "peripheral bus" can be configured to provide up to four output enable signals (10 in EPF81500A devices), and up to two clock or clear signals. Figure 13 on page 22 shows how two output enable signals are shared with one clock and one clear signal. The signals for the peripheral bus can be generated by any of the four dedicated inputs or signals on the row interconnect channels, as shown in Figure 13. The number of row channels in a row that can drive the peripheral bus correlates to the number of columns in the FLEX 8000 device. EPF8282A and EPF8282AV devices use 13 channels; EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices use 21 channels; and EPF81500A devices use 27 channels. The first LE in each LAB is the source of the row channel signal. The six peripheral control signals (12 in EPF81500A devices) can be accessed by each IOE.

Figure 13. FLEX 8000 Peripheral Bus



Numbers in parentheses are for EPF81500A devices.

Note:

- (1) n = 13 for EPF8282A and EPF8282AV devices.
 - *n* = 21 for EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices.
 - n = 27 for EPF81500A devices.

MultiVolt I/O Interface

The FLEX 8000 device architecture supports the MultiVolt I/O interface feature, which allows EPF81500A, EPF81188A, EPF8820A, and EPF8636A devices to interface with systems with differing supply voltages. These devices in all packages—except for EPF8636A devices in 84-pin PLCC packages—can be set for 3.3-V or 5.0-V I/O pin operation. These devices have one set of V_{CC} pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

The VCCINT pins must always be connected to a 5.0-V power supply. With a 5.0-V V_{CCINT} level, input voltages are at TTL levels and are therefore compatible with 3.3-V and 5.0-V inputs.

The VCCIO pins can be connected to either a 3.3-V or 5.0-V power supply, depending on the output requirements. When the VCCIO pins are connected to a 5.0-V power supply, the output levels are compatible with 5.0-V systems. When the VCCIO pins are connected to a 3.3-V power supply, the output high is at 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with V_{CCIO} levels lower than 4.75 V incur a nominally greater timing delay of t_{OD2} instead of t_{OD1} . See Table 8 on page 26.

IEEE Std. 1149.1 (JTAG) Boundary-Scan Support

The EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices provide JTAG BST circuitry. FLEX 8000 devices with JTAG circuitry support the JTAG instructions shown in Table 6.

Table 6. EPF8282A,	EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Instructions
JTAG Instruction	Description
SAMPLE/PRELOAD	Allows a snapshot of the signals at the device pins to be captured and examined during normal device operation, and permits an initial data pattern to be output at the device pins
EXTEST	Allows the external circuitry and board-level interconnections to be tested by forcing a test pattern at the output pins and capturing test results at the input pins.
BYPASS	Places the 1-bit bypass register between the TDI and TDO pins, which allows the BST data to pass synchronously through the selected device to adjacent devices during normal device operation.

Table 1	Table 10. FLEX 8000 5.0-V Device Recommended Operating Conditions								
Symbol	Parameter	Conditions	Min	Max	Unit				
V _{CCINT}	Supply voltage for internal logic and input buffers	(3), (4)	4.75 (4.50)	5.25 (5.50)	V				
V _{CCIO}	Supply voltage for output buffers, 5.0-V operation	(3), (4)	4.75 (4.50)	5.25 (5.50)	V				
	Supply voltage for output buffers, 3.3-V operation	(3), (4)	3.00 (3.00)	3.60 (3.60)	V				
VI	Input voltage		-0.5	V_{CCINT} + 0.5	V				
Vo	Output voltage		0	V _{CCIO}	V				
Τ _Α	Operating temperature	For commercial use	0	70	°C				
		For industrial use	-40	85	°C				
t _R	Input rise time			40	ns				
t _F	Input fall time			40	ns				

Table 1	Table 11. FLEX 8000 5.0-V Device DC Operating Conditions Notes (5), (6)									
Symbol	Parameter	Conditions	Min	Тур	Max	Unit				
V _{IH}	High-level input voltage		2.0		V_{CCINT} + 0.5	V				
V _{IL}	Low-level input voltage		-0.5		0.8	V				
V _{OH}	5.0-V high-level TTL output voltage	I _{OH} = -4 mA DC <i>(7)</i> V _{CCIO} = 4.75 V	2.4			V				
	3.3-V high-level TTL output voltage	I _{OH} = -4 mA DC <i>(7)</i> V _{CCIO} = 3.00 V	2.4			V				
	3.3-V high-level CMOS output voltage	I _{OH} = -0.1 mA DC (7) V _{CCIO} = 3.00 V	V _{CCIO} – 0.2			V				
V _{OL}	5.0-V low-level TTL output voltage	I _{OL} = 12 mA DC <i>(</i> 7 <i>)</i> V _{CCIO} = 4.75 V			0.45	V				
	3.3-V low-level TTL output voltage	I _{OL} = 12 mA DC <i>(</i> 7 <i>)</i> V _{CCIO} = 3.00 V			0.45	V				
	3.3-V low-level CMOS output voltage	I _{OL} = 0.1 mA DC <i>(7)</i> V _{CCIO} = 3.00 V			0.2	V				
I _I	Input leakage current	$V_{I} = V_{CC}$ or ground	-10		10	μA				
I _{OZ}	Tri-state output off-state current	$V_{O} = V_{CC}$ or ground	-40		40	μA				
I _{CC0}	V _{CC} supply current (standby)	V _I = ground, no load		0.5	10	mA				

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Symbol	Speed Grade							
	A-2		A	-3	A-4		1	
	Min	Мах	Min	Мах	Min	Max	1	
t _{IOD}		0.7		0.8		0.9	ns	
t _{IOC}		1.7		1.8		1.9	ns	
t _{IOE}		1.7		1.8		1.9	ns	
t _{IOCO}		1.0		1.0		1.0	ns	
t _{IOCOMB}		0.3		0.2		0.1	ns	
t _{IOSU}	1.4		1.6		1.8		ns	
t _{IOH}	0.0		0.0		0.0		ns	
t _{IOCLR}		1.2		1.2		1.2	ns	
t _{IN}		1.5		1.6		1.7	ns	
t _{OD1}		1.1		1.4		1.7	ns	
t _{OD2}		1.6		1.9		2.2	ns	
t _{OD3}		4.6		4.9		5.2	ns	
t _{XZ}		1.4		1.6		1.8	ns	
t _{ZX1}		1.4		1.6		1.8	ns	
t _{ZX2}		1.9		2.1		2.3	ns	
t _{ZX3}		4.9		5.1		5.3	ns	

Table 43. EPF81188A Interconnect Timing Parameters									
Symbol			Speed	l Grade			Unit		
	ļ	A-2		A-3		-4			
	Min	Max	Min	Max	Min	Max			
t _{LABCASC}		0.3		0.3		0.4	ns		
t _{LABCARRY}		0.3		0.3		0.4	ns		
t _{LOCAL}		0.5		0.6		0.8	ns		
t _{ROW}		5.0		5.0		5.0	ns		
t _{COL}		3.0		3.0		3.0	ns		
t _{DIN_C}		5.0		5.0		5.5	ns		
t _{DIN_D}		7.0		7.0		7.5	ns		
t _{DIN_IO}		5.0		5.0		5.5	ns		

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Table 44. EPF81188	Table 44. EPF81188A LE Timing Parameters									
Symbol			Speed	l Grade			Unit			
	A	-2	A	A-3		-4				
	Min	Max	Min	Max	Min	Max				
t _{LUT}		2.0		2.5		3.2	ns			
t _{CLUT}		0.0		0.0		0.0	ns			
t _{RLUT}		0.9		1.1		1.5	ns			
t _{GATE}		0.0		0.0		0.0	ns			
t _{CASC}		0.6		0.7		0.9	ns			
t _{CICO}		0.4		0.5		0.6	ns			
t _{CGEN}		0.4		0.5		0.7	ns			
t _{CGENR}		0.9		1.1		1.5	ns			
t _C		1.6		2.0		2.5	ns			
t _{CH}	4.0		4.0		4.0		ns			
t _{CL}	4.0		4.0		4.0		ns			
t _{CO}		0.4		0.5		0.6	ns			
t _{COMB}		0.4		0.5		0.6	ns			
t _{SU}	0.8		1.1		1.2		ns			
t _H	0.9		1.1		1.5		ns			
t _{PRE}		0.6		0.7		0.8	ns			
t _{CLR}		0.6		0.7		0.8	ns			

Table 45. EPF81188A External	Timing Parameters
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Symbol	Speed Grade						
	A	-2	A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t _{DRR}		16.0		20.0		25.0	ns
t _{ODH}	1.0		1.0		1.0		ns

Table 46. EPF81500A I/O Element Timing Parameters									
Symbol	Speed Grade								
	A-2		A-3		A-4		1		
	Min	Max	Min	Max	Min	Max	1		
t _{IOD}		0.7		0.8		0.9	ns		
t _{IOC}		1.7		1.8		1.9	ns		
t _{IOE}		1.7		1.8		1.9	ns		
t _{IOCO}		1.0		1.0		1.0	ns		
t _{IOCOMB}		0.3		0.2		0.1	ns		
t _{IOSU}	1.4		1.6		1.8		ns		
t _{IOH}	0.0		0.0		0.0		ns		
t _{IOCLR}		1.2		1.2		1.2	ns		
t _{IN}		1.5		1.6		1.7	ns		
t _{OD1}		1.1		1.4		1.7	ns		
t _{OD2}		1.6		1.9		2.2	ns		
t _{OD3}		4.6		4.9		5.2	ns		
t _{XZ}		1.4		1.6		1.8	ns		
t _{ZX1}		1.4		1.6		1.8	ns		
t _{ZX2}		1.9		2.1		2.3	ns		
t _{ZX3}		4.9		5.1		5.3	ns		

Symbol		Speed Grade							
	A-2		A-3		A-4				
	Min	Max	Min	Max	Min	Max	1		
t _{LABCASC}		0.3		0.3		0.4	ns		
t _{LABCARRY}		0.3		0.3		0.4	ns		
t _{LOCAL}		0.5		0.6		0.8	ns		
t _{ROW}		6.2		6.2		6.2	ns		
t _{COL}		3.0		3.0		3.0	ns		
t _{DIN_C}		5.0		5.0		5.5	ns		
t _{DIN_D}		8.2		8.2		8.7	ns		
t _{DIN_IO}		5.0		5.0		5.5	ns		

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Table 48. EPF81500A LE Timing Parameters								
Symbol	Speed Grade							
	A-2		A-3		A-4		1	
	Min	Max	Min	Max	Min	Max	1	
t _{LUT}		2.0		2.5		3.2	ns	
t _{CLUT}		0.0		0.0		0.0	ns	
t _{RLUT}		0.9		1.1		1.5	ns	
t _{GATE}		0.0		0.0		0.0	ns	
t _{CASC}		0.6		0.7		0.9	ns	
t _{CICO}		0.4		0.5		0.6	ns	
t _{CGEN}		0.4		0.5		0.7	ns	
t _{CGENR}		0.9		1.1		1.5	ns	
t _C		1.6		2.0		2.5	ns	
t _{CH}	4.0		4.0		4.0		ns	
t _{CL}	4.0		4.0		4.0		ns	
t _{CO}		0.4		0.5		0.6	ns	
t _{COMB}		0.4		0.5		0.6	ns	
t _{SU}	0.8		1.1		1.2		ns	
t _H	0.9		1.1		1.5		ns	
t _{PRE}		0.6		0.7		0.8	ns	
t _{CLR}		0.6		0.7		0.8	ns	

Table 49. EPF81500A External Timing Parameters	
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Symbol		Speed Grade						
	A	-2	A	-3	A-4			
	Min	Max	Min	Max	Min	Max		
t _{DRR}		16.1		20.1		25.1	ns	
t _{ODH}	1.0		1.0		1.0		ns	





Configuration & Operation



The FLEX 8000 architecture supports several configuration schemes to load a design into the device(s) on the circuit board. This section summarizes the device operating modes and available device configuration schemes.

For more information, go to *Application Note 33* (*Configuring FLEX 8000 Devices*) and *Application Note 38* (*Configuring Multiple FLEX 8000 Devices*).

Altera Corporation

Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A (1)		
ADD0	78	76	78	77	106	N3	6		
DATA7	3	2	90	89	131	P8	140		
DATA6	4	4	91	91	132	P10	139		
DATA5	6	6	92	95	133	R12	138		
DATA4	7	7	95	96	134	R13	136		
DATA3	8	8	97	97	135	P13	135		
DATA2	9	9	99	98	137	R14	133		
DATA1	13	13	4	4	138	N15	132		
DATA0	14	14	5	5	140	K13	129		
SDOUT (3)	79	78	79	79	23	P4	97		
TDI <i>(4)</i>	55	45 (5)	54	-	96	-	17		
TDO (4)	27	27 (5)	18	-	18	-	102		
TCK (4), (6)	72	44 (5)	72	-	88	-	27		
TMS (4)	20	43 (5)	11	-	86	-	29		
TRST (7)	52	52 (8)	50	-	71	-	45		
Dedicated	12, 31, 54,	12, 31, 54,	3, 23, 53, 73	3, 24, 53,	9, 26, 82,	C3, D14,	14, 33, 94,		
Inputs (10)	73	73		74	99	N2, R15	113		
VCCINT	17, 38, 59, 80	17, 38, 59, 80	6, 20, 37, 56, 70, 87	9, 32, 49, 59, 82	8, 28, 70, 90, 111	B2, C4, D3, D8, D12, G3, G12, H4, H13, J3, J12, M4, M7, M9, M13, N12	3, 24, 46, 92, 114, 160		
VCCIO	-	_	-	-	16, 40, 60, 69, 91, 112, 122, 141	_	23, 47, 57, 69, 79, 104, 127, 137, 149, 159		

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Table 54. FLEX 8000 225-, 232-, 240-, 280- & 304-Pin Package Pin-Outs (Part 3 of 3)								
Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A		
GND	B1, D4, E14, F7, F8, F9, F12, G6, G7, G8, G9, G10, H1, H4, H5, H6, H7, H8, H9, H10, H11, J6, J7, J8, J9, J10, K6, K7, K8, K9, K11, L15, N3, P1	A1, D6, E11, E7, E9, G4, G5, G13, G14, J5, J13, K4, K14, L5, L13, N4, N7, N9, N11, N14	8, 9, 30, 31, 52, 53, 72, 90, 108, 115, 129, 139, 151, 161, 173, 185, 187, 193, 211, 229	6, 7, 28, 29, 50, 51, 71, 85, 92, 101, 118, 119, 140, 141, 162, 163, 184, 185, 186, 198, 208, 214, 228	D4, D5, D16, E4, E5, E6, E15, E16, F5, F15, G5, G15, H5, H15, J5, J15, K5, K15, L5, L15, M5, M15, N5, N15, P4, P5, P15, P16, R4, R5, R15, R16, T4, T5, T16, U17	9, 11, 36, 38, 65, 67, 90, 108, 116, 128, 150, 151, 175, 177, 206, 208, 231, 232, 237, 253, 265, 273, 291		
No Connect (N.C.)	_	_	61, 62, 119, 120, 181, 182, 239, 240	_	_	10, 21, 23, 25, 35, 37, 39, 40, 41, 42, 52, 55, 66, 68, 146, 147, 161, 173, 174, 176, 187, 188, 189, 190, 192, 194, 195, 205, 207, 219, 221, 233, 234, 235, 236, 302, 303		
Total User I/O Pins (9)	148	180	180	177	204	204		

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Notes to tables:

- Perform a complete thermal analysis before committing a design to this device package. See Application Note 74 (Evaluating Power for Altera Devices) for more information.
- (2) This pin is a dedicated pin and is not available as a user I/O pin.
- (3) SDOUT will drive out during configuration. After configuration, it may be used as a user I/O pin. By default, the MAX+PLUS II software will not use SDOUT as a user I/O pin; the user can override the MAX+PLUS II software and use SDOUT as a user I/O pin.
- (4) If the device is not configured to use the JTAG BST circuitry, this pin is available as a user I/O pin.
- (5) JTAG pins are available for EPF8636A devices only. These pins are dedicated user I/O pins.
- (6) If this pin is used as an input in user mode, ensure that it does not toggle before or during configuration.
- (7) TRST is a dedicated input pin for JTAG use. This pin must be grounded if JTAG BST is not used.
- (8) Pin 52 is a V_{CC} pin on EPF8452A devices only.
- (9) The user I/O pin count includes dedicated input pins and all I/O pins.
- (10) Unused dedicated inputs should be tied to ground on the board.
- (11) SDOUT does not exist in the EPF8636GC192 device.
- (12) These pins are no connect (N.C.) pins for EPF8636A devices only. They are user I/O pins in EPF8820A devices.
- (13) EPF8636A devices have 132 user I/O pins; EPF8820A devices have 148 user I/O pins.
- (14) For EPF81500A devices, these pins are dedicated JTAG pins and are not available as user I/O pins. If JTAG BST is not used, TDI, TCK, TMS, and TRST should be tied to GND.

Revision History The information contained in the *FLEX 8000 Programmable Logic Device Family Data Sheet* version 11.1 supersedes information published in previous versions. The *FLEX 8000 Programmable Logic Device Family Data Sheet* version 11.1 contains the following change: minor textual updates.